Part Number : 447691002
Product Description : Micro-Fit BMI Receptacle Header, Dual Row, Vertical, with Press-fit Plastic Pegs, 0.38µm Gold (Au) Selective, 10 Circuits
Series Number : 44769
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

447691002_sd.pdf

PK-44769-001-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

SYM-44769-1001-001.zip

Specifications

PS-44300-001-001.pdf

443000002-TS-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	44769
Description	Micro-Fit BMI Receptacle Header, Dual Row, Vertical, with Press-fit Plastic Pegs, 0.38µm Gold (Au) Selective, 10 Circuits
Application	Board-to-Board, Power, Wire-to-Board
Component Type	PCB Receptacle
Product Name	Micro-Fit BMI
UPC	800756568201

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	8.5A
Voltage - Maximum	600V

Physical

Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
Durability (mating cycles max)	30
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Liquid Crystal Polymer
Net Weight	1.932/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
PC Tail Length	3.40mm
Pitch - Mating Interface	3.00mm
Plating min - Mating	0.381µm
Plating min - Termination	2.540µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Micro-Fit BMI Dual Row Plug Housings	44300
Micro-Fit BMI Right-Angle Dual Row Headers	44428
Micro-Fit BMI Vertical Dual Row Headers	44432
Micro-Fit BMI CPI Vertical Dual Row Headers	45280